IRF530

Vishay Siliconix



TO-220AB

PRODUCT SUMMARY

V_{DS} (V)

R_{DS(on)} (Ω)

Q_{gs} (nC)

Q_{gd} (nC)

Q_a max. (nC)

Configuration

Power MOSFET

S

N-Channel MOSFET

0.16

100

26

5.5

11

Single

 $V_{GS} = 10 V$

FEATURES

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- 175 °C operating temperature
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF530PbF
Lead (Pb)-free and halogen-free	IRF530PbF-BE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-source voltage			V _{DS}	100	Ň	
Gate-source voltage			V _{GS}	± 20	- V	
Continuous drain surrant	V _{GS} at 10 V	T _C = 25 °C		14		
Continuous drain current		T _C = 100 °C	I _D	10	А	
Pulsed drain current ^a			I _{DM}	56		
Linear derating factor				0.59	W/°C	
Single pulse avalanche energy ^b			E _{AS}	69	mJ	
Repetitive avalanche current ^a			I _{AR}	14	А	
Repetitive avalanche energy ^a			E _{AR}	8.8	mJ	
Maximum power dissipation	T _C = 25 °C		PD	88	W	
Peak diode recovery dV/dt ^c			dV/dt	5.5	V/ns	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C		
Soldering recommendations (peak temperature) ^d	For 10 s			300		
Mounting torque	6-32 or M3 screw			10	lbf ∙ in	
Mounting torque			-	1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. V_{DD} = 25 V, starting T_J = 25 °C, L = 528 µH, R_g = 25 Ω , I_{AS} = 14 A (see fig. 12)

c. $I_{SD} \le 14$ A, dI/dt ≤ 140 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C

d. 1.6 mm from case

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	-		62				
Case-to-sink, flat, greased surface	R _{thCS}	0.50					°C/W	
Maximum junction-to-case (drain)	R _{thJC}	- 1.7						
	•							
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, u	Inless otherw	ise noted)						
PARAMETER	SYMBOL	TEST	CONDITIC	ONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0	V, I _D = 25	0 µA	100	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference t	:o 25 °C, I _C	₀ = 1 mA	-	0.12	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{C}$	_{GS} , I _D = 25	0 μA	2.0	-	4.0	V
Gate-source leakage	I _{GSS}	V _G	_S = ± 20 V		-	-	± 100	nA
Zara gata valtaga drain overant	1	V _{DS} = 10	00 V, V _{GS} :	= 0 V	-	-	25	
Zero gate voltage drain current	IDSS	V _{DS} = 80 V, V ₀	_{GS} = 0 V, T	J = 150 °C	-	-	250	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D :	= 8.4 A ^b	-	-	0.16	Ω
Forward transconductance	g _{fs}	V _{DS} = 50	0 V, I _D = 8.	4 A ^b	5.1	-	-	S
Dynamic					•			•
Input capacitance	C _{iss}	- 670 -						
Output capacitance	C _{oss}	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	250	-	pF	
Reverse transfer capacitance	C _{rss}			-	60	-		
Total gate charge	Qg			= 14 A, V _{DS} = 80 V, ee fig. 6 and 13 ^b	-	-	26	nC
Gate-source charge	Q _{gs}	$V_{GS} = 10 \text{ V}$			-	-	5.5	
Gate-drain charge	Q _{gd}				-	-	11	
Turn-on delay time	t _{d(on)}				-	10	-	
Rise time	t _r	V _{DD} = 5	50 V, I _D = 1	14 A	-	34	-	
Turn-off delay time	t _{d(off)}	$R_g = 12 \Omega$, $R_D = 3.6 \Omega$, see fig. 10 ^b		-	23	-	ns	
Fall time	t _f			-	24	-		
Gate input resistance	Rg	f = 1 MHz, open drain		1.0	-	4.7	Ω	
Internal drain inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH	
Internal source inductance	L _S			-	7.5	-		
Drain-Source Body Diode Characteristic	cs							
Continuous source-drain diode current	١ _S	MOSFET symbol showing the integral reverse p - n junction diode		14	A			
Pulsed diode forward current ^a	lau i			-	-	56	~	
	I _{SM}	· · ·						
Body diode voltage	V _{SD}	T _J = 25 °C, I _S	₆ = 14 A, V	_{GS} = 0 V ^b	-	-	2.5	V
Body diode voltage Body diode reverse recovery time		T _J = 25 °C, I _S			-	- 150	2.5 280	V ns
, 0	V _{SD}				1			

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

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Document Number: 91019

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

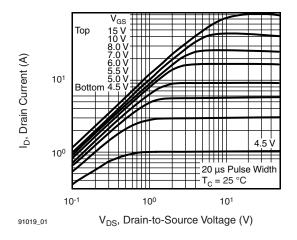


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

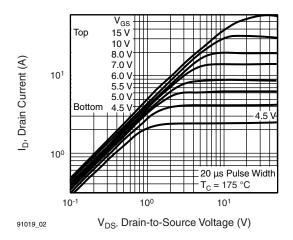
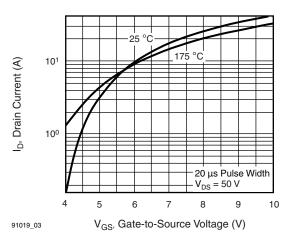


Fig. 2 - Typical Output Characteristics, $T_C = 175 \ ^{\circ}C$





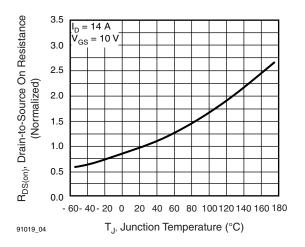


Fig. 4 - Normalized On-Resistance vs. Temperature

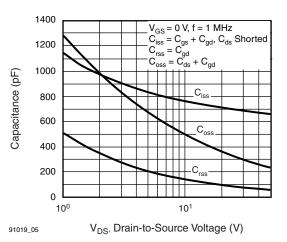


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

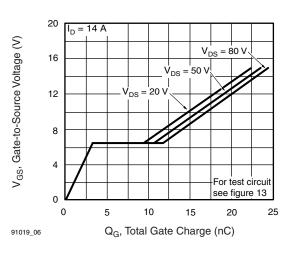


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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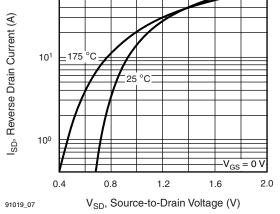


Fig. 7 - Typical Source-Drain Diode Forward Voltage

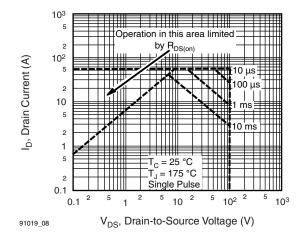


Fig. 8 - Maximum Safe Operating Area

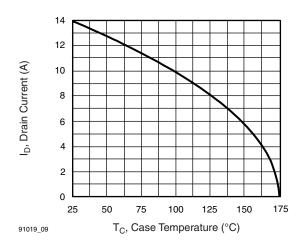


Fig. 9 - Maximum Drain Current vs. Case Temperature

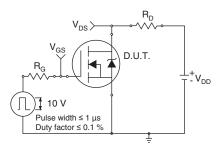


Fig. 10a - Switching Time Test Circuit

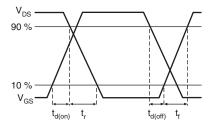


Fig. 10b - Switching Time Waveforms

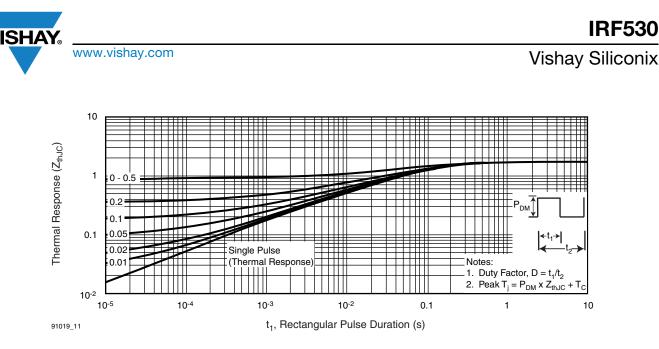


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

V_{DS}

I_{AS}

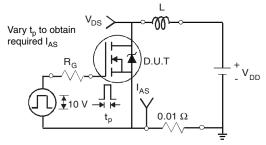


Fig. 12a - Unclamped Inductive Test Circuit

Fig. 12b - Unclamped Inductive Waveforms

/_{DS}

 V_{DD}

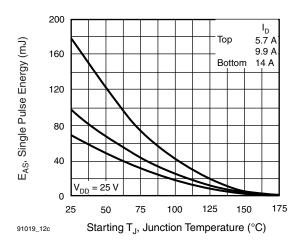


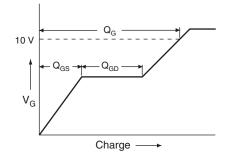
Fig. 12c - Maximum Avalanche Energy vs. Drain Current

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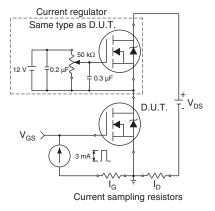
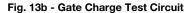


Fig. 13a - Basic Gate Charge Waveform



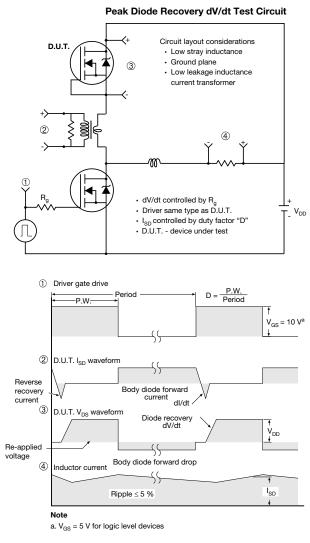


Fig. 14 - For N-Channel

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TO-220-1



D 114	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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